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				Examiner Name	Jonathan Han	
Sheet	1	of	1	Attorney Docket Number	062092	

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	No.1	Country Code ³	Number ⁴	Kind Code ⁵ (if known)	MM-DD-YYYY	Applicant of Cited Document	Translation ⁶
	2	JP	2000-164746		6/16/2000	Sumitomo Special Metals Co Ltd	Abstract
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NON PATENT LITERATURE DOCUMENTS							
Examiner Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.					
8		T. YAMAMOTO et al., "Evaluation of Reactivity between Sn-Ag Solder and Au/Ni-Co Plating to", 10 th Symposium on "Microjoining and Assembly Technology in Electronics, Feb. 5-6, 2004 pp. 117-122					
9	International Search Report of International Application PCT/JP2005/017599 mailed November 15, 2005						

Examiner Signature	/Jonathan Han/	Date Considered	05/29/2009	

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